

HEF4053B

Triple single-pole double-throw analog switch

Rev. 14 — 25 July 2024

Product data sheet

1. General description

The HEF4053B is a triple single-pole double-throw analog switch (3x SPDT) suitable for use in analog or digital 2:1 multiplexer/demultiplexer applications. Each switch features a digital select input (Sn), two independent inputs/outputs (Y0 and Y1) and a common input/output (Z). A digital enable input (E) is common to all switches. When \bar{E} is HIGH, the switches are turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{DD} .

2. Features and benefits

- Wide supply voltage range from 3.0 V to 15.0 V
- CMOS low power dissipation
- High noise immunity
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Complies with JEDEC standard JESD 13-B
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +125 °C

3. Applications

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

4. Ordering information

Table 1. Ordering information

| Type number | Package | | | Version |
|----------------------------|-------------------|---------|--|--------------------------|
| | Temperature range | Name | Description | |
| HEF4053BT | -40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| HEF4053BTT | -40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |

5. Functional diagram

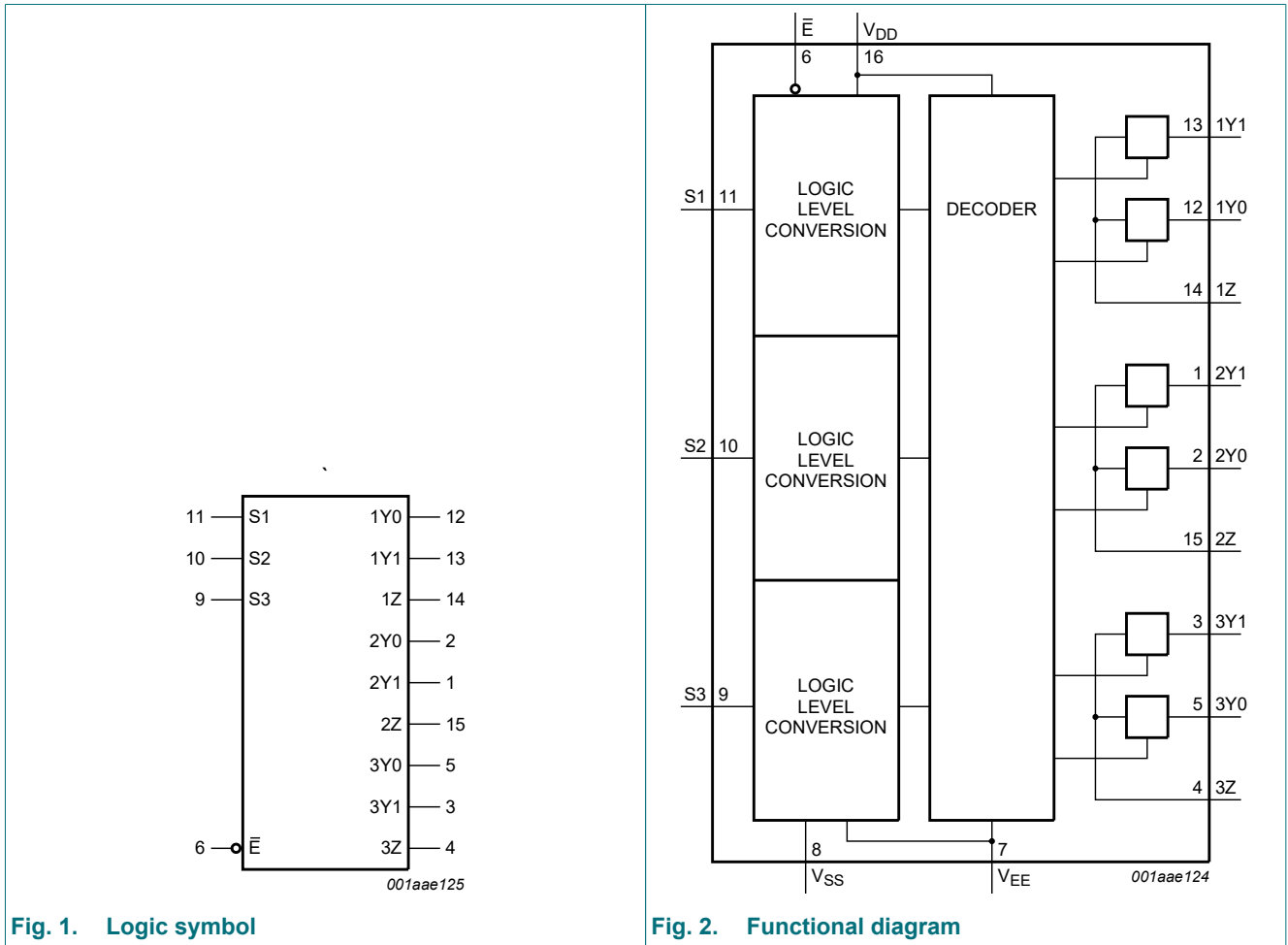


Fig. 1. Logic symbol

Fig. 2. Functional diagram

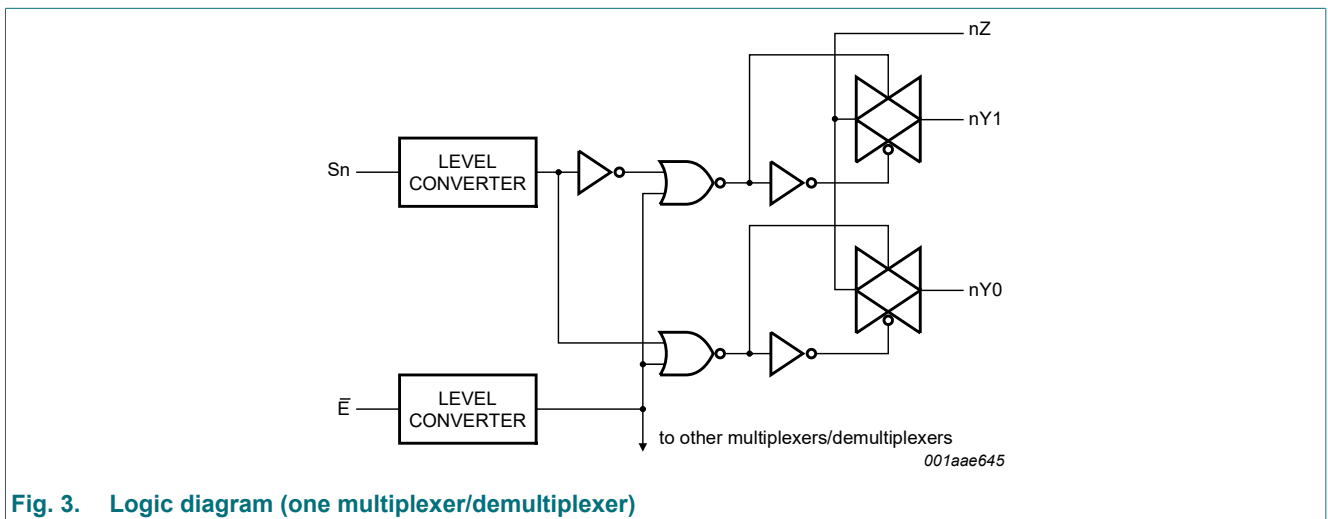


Fig. 3. Logic diagram (one multiplexer/demultiplexer)

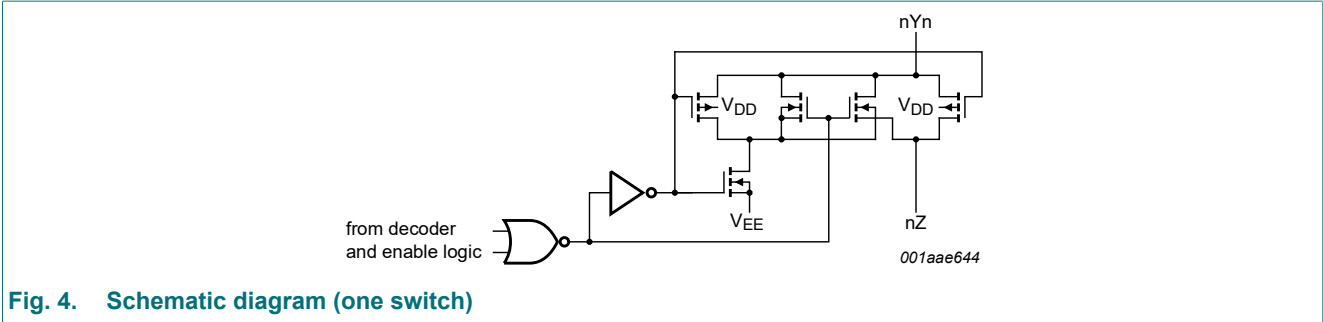


Fig. 4. Schematic diagram (one switch)

6. Pinning information

6.1. Pinning

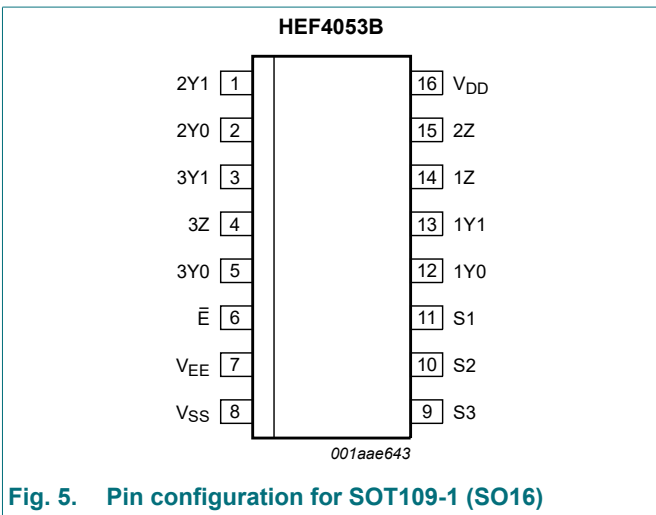


Fig. 5. Pin configuration for SOT109-1 (SO16)

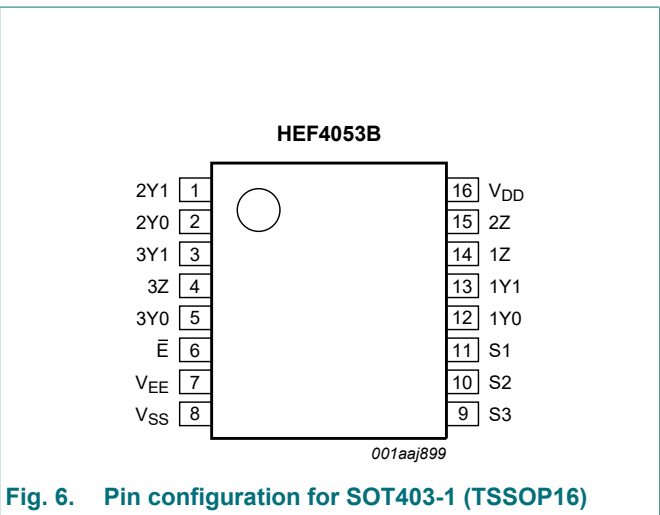


Fig. 6. Pin configuration for SOT403-1 (TSSOP16)

6.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|---------------|-----------|-----------------------------|
| \bar{E} | 6 | enable input (active LOW) |
| V_{EE} | 7 | supply voltage |
| V_{SS} | 8 | ground supply voltage |
| S1, S2, S3 | 11, 10, 9 | select input |
| 1Y0, 2Y0, 3Y0 | 12, 2, 5 | independent input or output |
| 1Y1, 2Y1, 3Y1 | 13, 1, 3 | independent input or output |
| 1Z, 2Z, 3Z | 14, 15, 4 | independent output or input |
| V_{DD} | 16 | supply voltage |

7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

| Inputs | | Channel on |
|-----------|----|--------------|
| \bar{E} | Sn | |
| L | L | nY0 to nZ |
| L | H | nY1 to nZ |
| H | X | switches OFF |

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0\text{ V}$ (ground).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|---|---------|----------------|------|
| V_{DD} | supply voltage | | -0.5 | +18 | V |
| V_{EE} | supply voltage | referenced to V_{DD} | [1] -18 | +0.5 | V |
| I_{IK} | input clamping current | pins Sn and \bar{E} ; $V_I < -0.5\text{ V}$ or $V_I > V_{DD} + 0.5\text{ V}$ | - | ± 10 | mA |
| V_I | input voltage | | -0.5 | $V_{DD} + 0.5$ | V |
| $I_{I/O}$ | input/output current | | - | ± 10 | mA |
| I_{DD} | supply current | | - | 50 | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| T_{amb} | ambient temperature | | -40 | +125 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$ | [2] - | 500 | mW |
| P | power dissipation | per output | - | 100 | mW |

- [1] To avoid drawing V_{DD} current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{DD} current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V_{DD} or V_{EE} .
- [2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.
For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------------|------------------------|-----|-----|----------|-----------------|
| V_{DD} | supply voltage | see Fig. 7 | 3 | - | 15 | V |
| V_I | input voltage | | 0 | - | V_{DD} | V |
| T_{amb} | ambient temperature | in free air | -40 | - | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{DD} = 5\text{ V}$ | - | - | 3.75 | $\mu\text{s/V}$ |
| | | $V_{DD} = 10\text{ V}$ | - | - | 0.5 | $\mu\text{s/V}$ |
| | | $V_{DD} = 15\text{ V}$ | - | - | 0.08 | $\mu\text{s/V}$ |

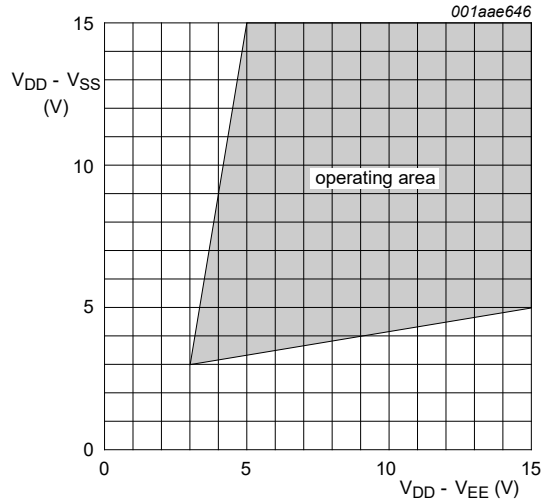


Fig. 7. Operating area as a function of the supply voltages

10. Static characteristics

Table 6. Static characteristics

$V_{SS} = V_{EE} = 0\text{ V}$; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

| Symbol | Parameter | Conditions | V_{DD} | $T_{amb} = -40\text{ °C}$ | | $T_{amb} = +25\text{ °C}$ | | $T_{amb} = +85\text{ °C}$ | | $T_{amb} = +125\text{ °C}$ | | Unit |
|--------------|---------------------------|--------------------------------------|----------|---------------------------|-----------|---------------------------|-----------|---------------------------|-----------|----------------------------|-----------|---------------|
| | | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| V_{IH} | HIGH-level input voltage | $ I_O < 1\text{ }\mu\text{A}$ | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | 3.5 | - | V |
| | | | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | 7.0 | - | V |
| | | | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | 11.0 | - | V |
| V_{IL} | LOW-level input voltage | $ I_O < 1\text{ }\mu\text{A}$ | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | - | 1.5 | V |
| | | | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | - | 3.0 | V |
| | | | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | - | 4.0 | V |
| I_I | input leakage current | | 15 V | - | ± 0.1 | - | ± 0.1 | - | ± 1.0 | - | ± 1.0 | μA |
| $I_{S(OFF)}$ | OFF-state leakage current | Z port; all channels OFF; see Fig. 8 | 15 V | - | - | - | 1000 | - | - | - | - | nA |
| | | Y port; per channel; see Fig. 9 | 15 V | - | - | - | 200 | - | - | - | - | nA |
| I_{DD} | supply current | $I_O = 0\text{ A}$ | 5 V | - | 5 | - | 5 | - | 150 | - | 150 | μA |
| | | | 10 V | - | 10 | - | 10 | - | 300 | - | 300 | μA |
| | | | 15 V | - | 20 | - | 20 | - | 600 | - | 600 | μA |
| C_I | input capacitance | Sn, \bar{E} inputs | - | - | - | 7.5 | - | - | - | - | pF | |

10.1. Test circuits

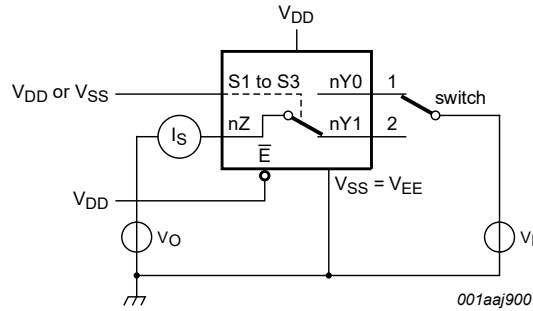


Fig. 8. Test circuit for measuring OFF-state leakage current Z port

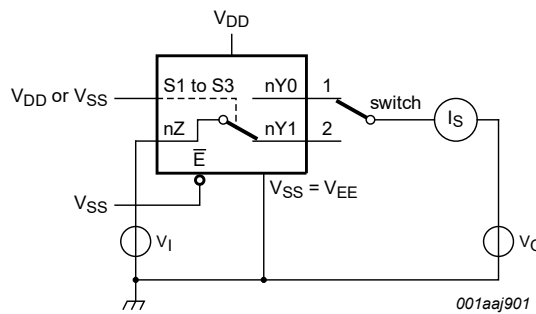


Fig. 9. Test circuit for measuring OFF-state leakage current nYn port

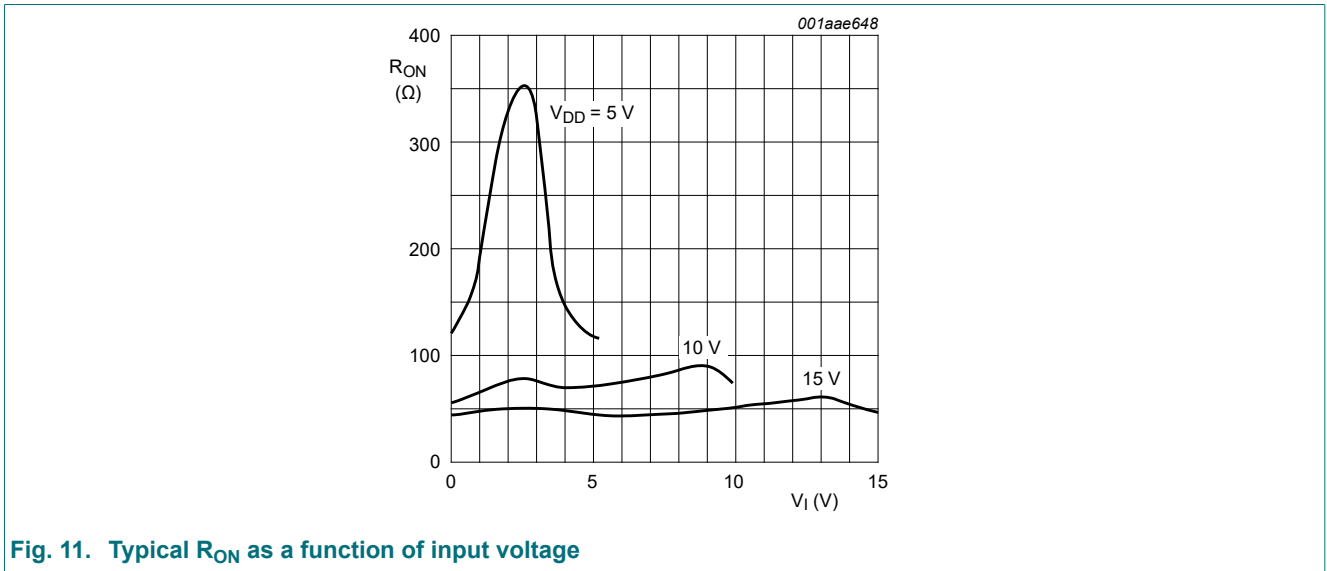
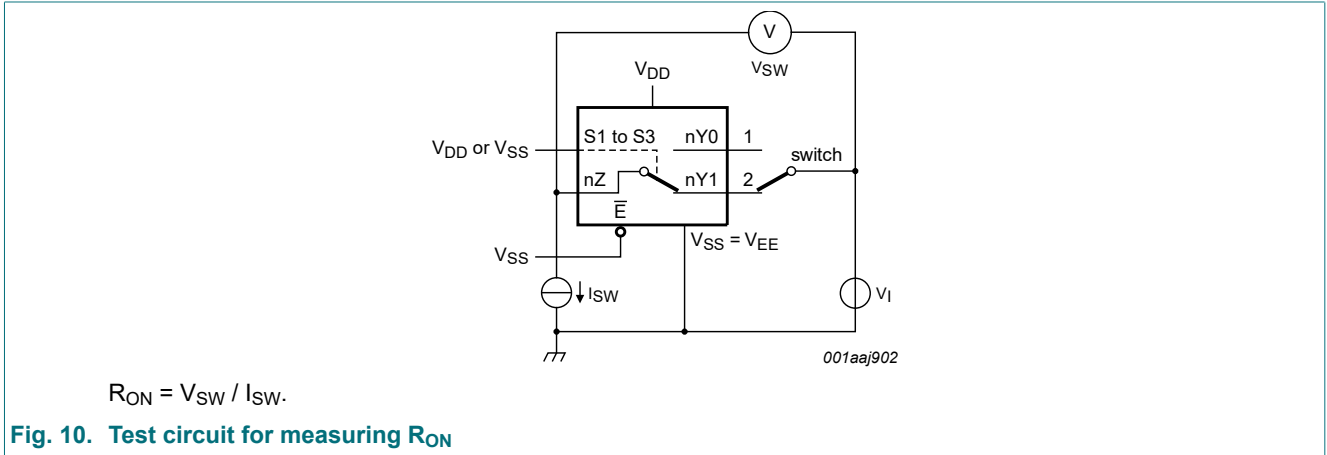
10.2. ON resistance

Table 7. ON resistance

$T_{amb} = 25\text{ }^{\circ}\text{C}$; $I_{SW} = 200\text{ }\mu\text{A}$; $V_{SS} = V_{EE} = 0\text{ V}$.

| Symbol | Parameter | Conditions | $V_{DD} - V_{EE}$ | Typ | Max | Unit |
|-----------------|---|--|-------------------|-----|------|----------|
| $R_{ON(peak)}$ | ON resistance (peak) | $V_I = 0\text{ V to }V_{DD} - V_{EE}$; see Fig. 10 and Fig. 11 | 5 V | 350 | 2500 | Ω |
| | | | 10 V | 80 | 245 | Ω |
| | | | 15 V | 60 | 175 | Ω |
| $R_{ON(rail)}$ | ON resistance (rail) | $V_I = 0\text{ V}$; see Fig. 10 and Fig. 11 | 5 V | 115 | 340 | Ω |
| | | | 10 V | 50 | 160 | Ω |
| | | | 15 V | 40 | 115 | Ω |
| | | $V_I = V_{DD} - V_{EE}$; see Fig. 10 and Fig. 11 | 5 V | 120 | 365 | Ω |
| | | | 10 V | 65 | 200 | Ω |
| | | | 15 V | 50 | 155 | Ω |
| ΔR_{ON} | ON resistance mismatch between channels | $V_I = 0\text{ V to }V_{DD} - V_{EE}$; see Fig. 10 | 5 V | 25 | - | Ω |
| | | | 10 V | 10 | - | Ω |
| | | | 15 V | 5 | - | Ω |

10.2.1. ON resistance waveform and test circuit



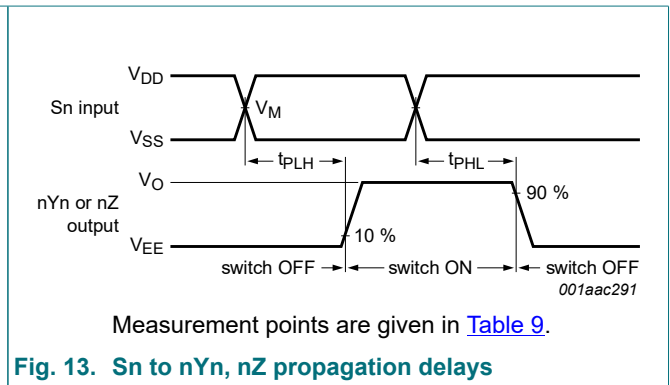
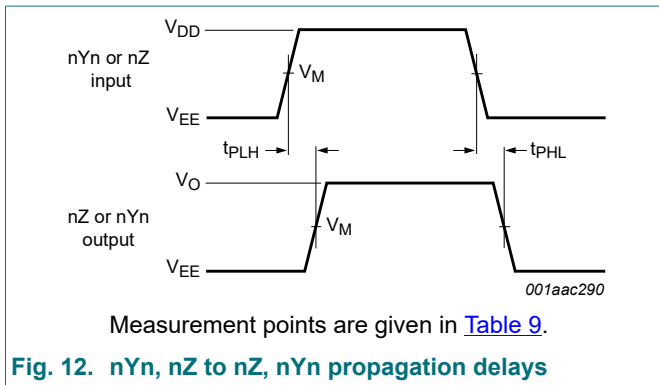
11. Dynamic characteristics

Table 8. Dynamic characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$; $V_{SS} = V_{EE} = 0\text{ V}$; for test circuit see [Fig. 15](#).

| Symbol | Parameter | Conditions | V _{DD} | Typ | Max | Unit |
|------------------|-------------------------------------|---|-----------------|-----|-----|------|
| t _{PHL} | HIGH to LOW propagation delay | nYn, nZ to nZ, nYn; see Fig. 12 | 5 V | 10 | 20 | ns |
| | | | 10 V | 5 | 10 | ns |
| | | | 15 V | 5 | 10 | ns |
| | | Sn to nYn, nZ; see Fig. 13 | 5 V | 200 | 400 | ns |
| | | | 10 V | 85 | 170 | ns |
| | | | 15 V | 65 | 130 | ns |
| t _{PLH} | LOW to HIGH propagation delay | nYn, nZ to nZ, nYn; see Fig. 12 | 5 V | 15 | 30 | ns |
| | | | 10 V | 5 | 10 | ns |
| | | | 15 V | 5 | 10 | ns |
| | | Sn to nYn, nZ; see Fig. 13 | 5 V | 275 | 555 | ns |
| | | | 10 V | 100 | 200 | ns |
| | | | 15 V | 65 | 130 | ns |
| t _{PHZ} | HIGH to OFF-state propagation delay | \bar{E} to nYn, nZ; see Fig. 14 | 5 V | 200 | 400 | ns |
| | | | 10 V | 115 | 230 | ns |
| | | | 15 V | 110 | 220 | ns |
| t _{PZH} | OFF-state to HIGH propagation delay | \bar{E} to nYn, nZ; see Fig. 14 | 5 V | 260 | 525 | ns |
| | | | 10 V | 95 | 190 | ns |
| | | | 15 V | 65 | 130 | ns |
| t _{PLZ} | LOW to OFF-state propagation delay | \bar{E} to nYn, nZ; see Fig. 14 | 5 V | 200 | 400 | ns |
| | | | 10 V | 120 | 245 | ns |
| | | | 15 V | 110 | 215 | ns |
| t _{PZL} | OFF-state to LOW propagation delay | \bar{E} to nYn, nZ; see Fig. 14 | 5 V | 280 | 565 | ns |
| | | | 10 V | 105 | 205 | ns |
| | | | 15 V | 70 | 140 | ns |

11.1. Waveforms and test circuit



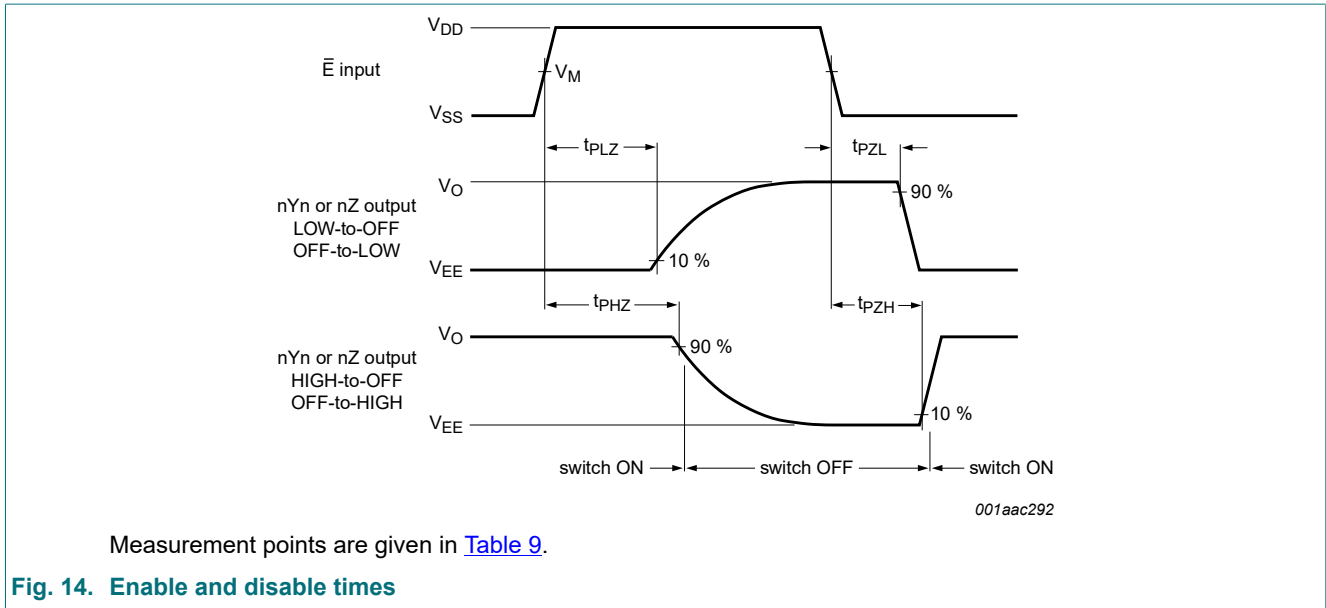


Table 9. Measurement points

| Supply voltage | Input | Output |
|----------------|-------------|-------------|
| V_{DD} | V_M | V_M |
| 5 V to 15 V | $0.5V_{DD}$ | $0.5V_{DD}$ |

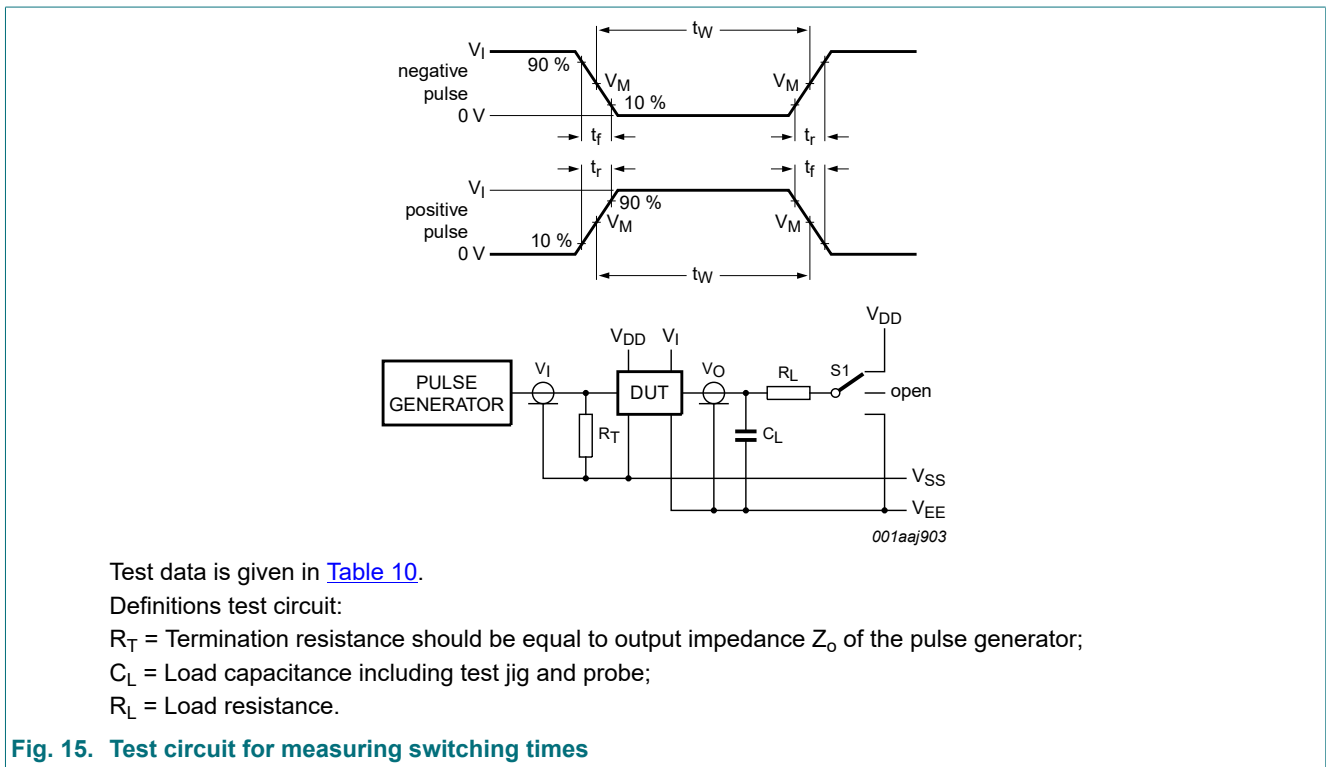


Table 10. Test data

| Input | | | | Load | | S1 position | | | | |
|----------------------|----------------------|--------------|-------------|-------|---------------|----------------------|-----------|--------------------|--------------------|----------|
| nYn, nZ | Sn and E | t_r, t_f | V_M | C_L | R_L | t_{PHL} [1] | t_{PLH} | t_{PZH}, t_{PHZ} | t_{PZL}, t_{PLZ} | other |
| V_{DD} or V_{EE} | V_{DD} or V_{SS} | ≤ 20 ns | $0.5V_{DD}$ | 50 pF | 10 k Ω | V_{DD} or V_{EE} | V_{EE} | V_{EE} | V_{DD} | V_{EE} |

[1] For nYn to nZ or nZ to nYn propagation delays use V_{EE} . For Sn to nYn or nZ propagation delays use V_{DD} .

11.2. Additional dynamic parameters

Table 11. Additional dynamic characteristics

$V_{SS} = V_{EE} = 0\text{ V}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$.

| Symbol | Parameter | Conditions | V_{DD} | Typ | Max | Unit |
|---------------------|---------------------------|---|----------|------|-----|------|
| THD | total harmonic distortion | see Fig. 16; $R_L = 10\text{ k}\Omega$; $C_L = 15\text{ pF}$; channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1\text{ kHz}$ | [1] 5 V | 0.25 | - | % |
| | | | 10 V | 0.04 | - | % |
| | | | 15 V | 0.04 | - | % |
| $f_{(-3\text{dB})}$ | -3 dB frequency response | see Fig. 17; $R_L = 1\text{ k}\Omega$; $C_L = 5\text{ pF}$; channel ON; $V_I = 0.5V_{DD}$ (p-p) | [1] 5 V | 13 | - | MHz |
| | | | 10 V | 40 | - | MHz |
| | | | 15 V | 70 | - | MHz |
| α_{iso} | isolation (OFF-state) | see Fig. 18; $f_i = 1\text{ MHz}$; $R_L = 1\text{ k}\Omega$; $C_L = 5\text{ pF}$; channel OFF; $V_I = 0.5V_{DD}$ (p-p) | [1] 10 V | -50 | - | dB |
| V_{ct} | crosstalk voltage | digital inputs to switch; see Fig. 19; $R_L = 10\text{ k}\Omega$; $C_L = 15\text{ pF}$; \bar{E} or $S_n = V_{DD}$ (square-wave) | 10 V | 50 | - | mV |
| Xtalk | crosstalk | between switches; see Fig. 20; $f_i = 1\text{ MHz}$; $R_L = 1\text{ k}\Omega$; $V_I = 0.5V_{DD}$ (p-p) | [1] 10 V | -50 | - | dB |

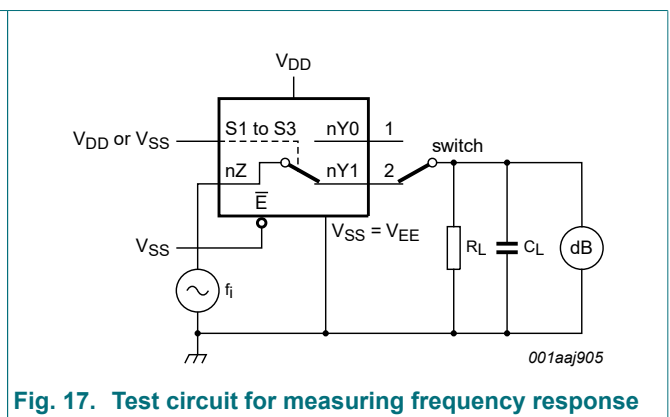
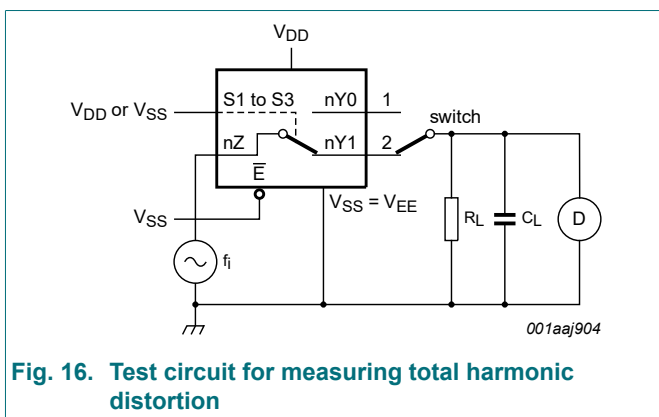
[1] f_i is biased at $0.5 V_{DD}$; $V_I = 0.5V_{DD}$ (p-p).

Table 12. Dynamic power dissipation

P_D can be calculated from the formulas shown; $V_{EE} = V_{SS} = 0\text{ V}$; $t_r = t_f \leq 20\text{ ns}$; $T_{amb} = 25\text{ }^{\circ}\text{C}$.

| Symbol | Parameter | V_{DD} | Typical formula for P_D (μW) | where: |
|--------|---------------------------|----------|---|--|
| P_D | dynamic power dissipation | 5 V | $P_D = 2500 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ | f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF; V_{DD} = supply voltage in V; $\Sigma(C_L \times f_o)$ = sum of the outputs. |
| | | 10 V | $P_D = 11500 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ | |
| | | 15 V | $P_D = 29000 \times f_i + \Sigma(f_o \times C_L) \times V_{DD}^2$ | |

11.2.1. Test circuits



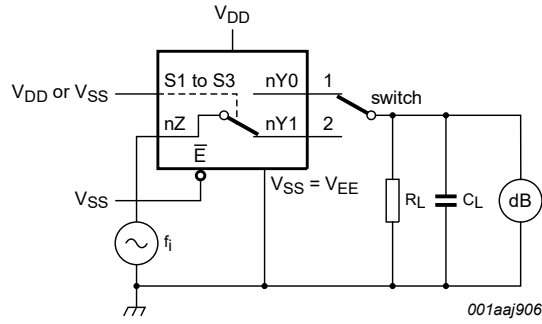
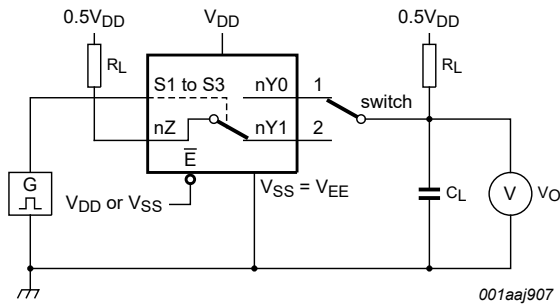
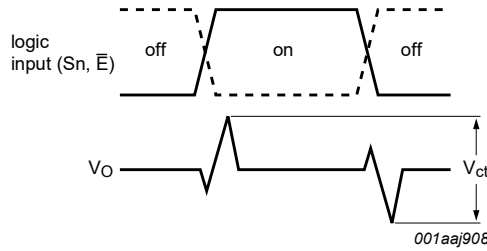


Fig. 18. Test circuit for measuring isolation (OFF-state)

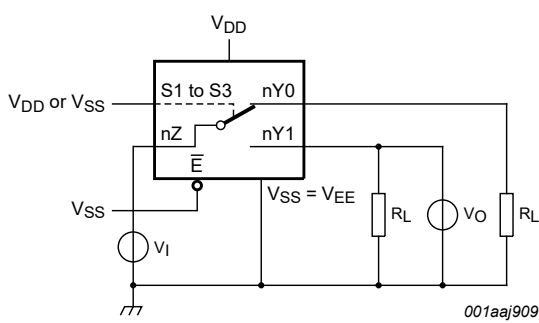


a. Test circuit

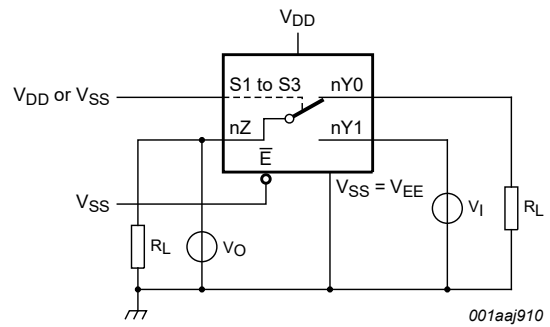


b. Input and output pulse definitions

Fig. 19. Test circuit for measuring crosstalk voltage between digital inputs and switch



a. Switch closed condition



b. Switch open condition

Fig. 20. Test circuit for measuring crosstalk between switches

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

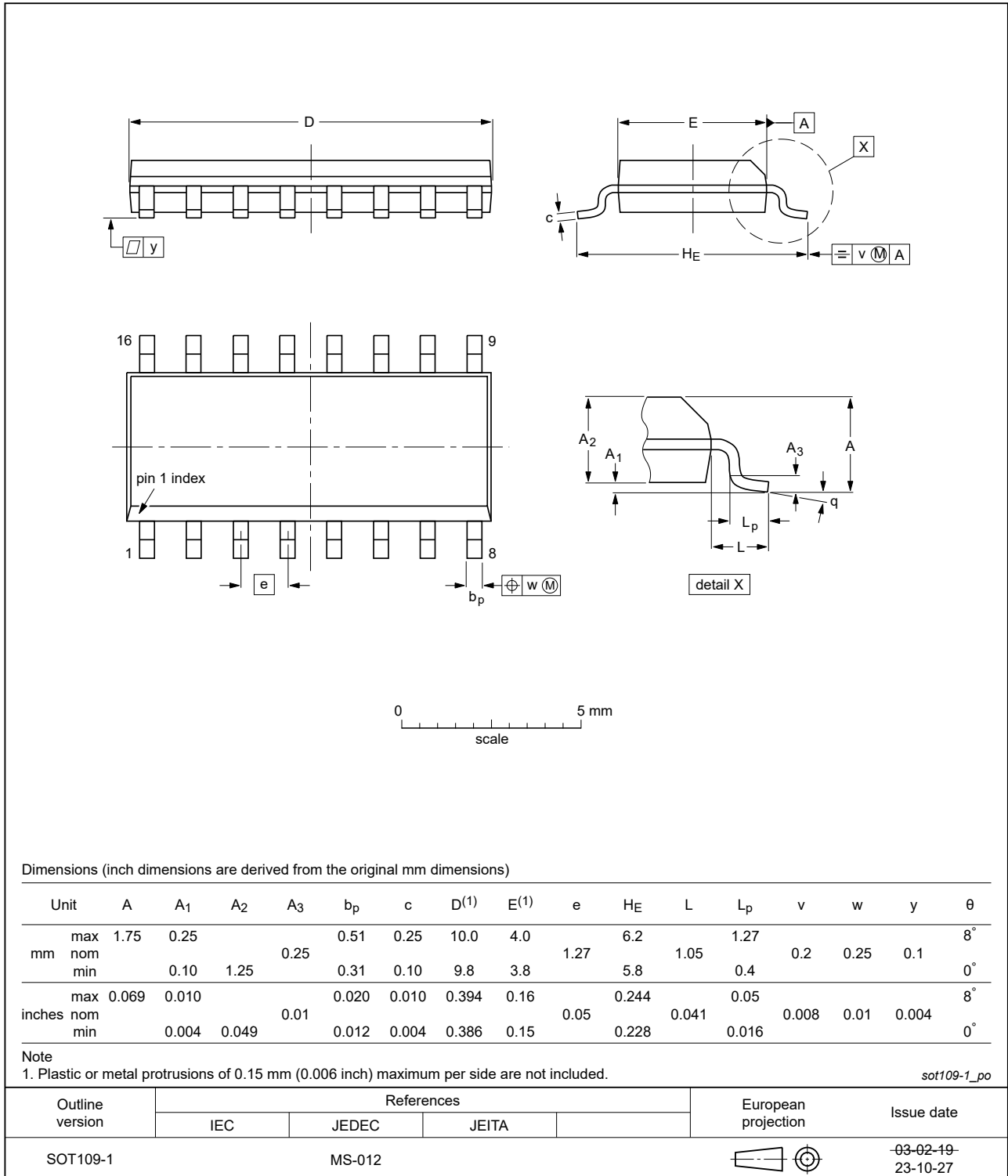


Fig. 21. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

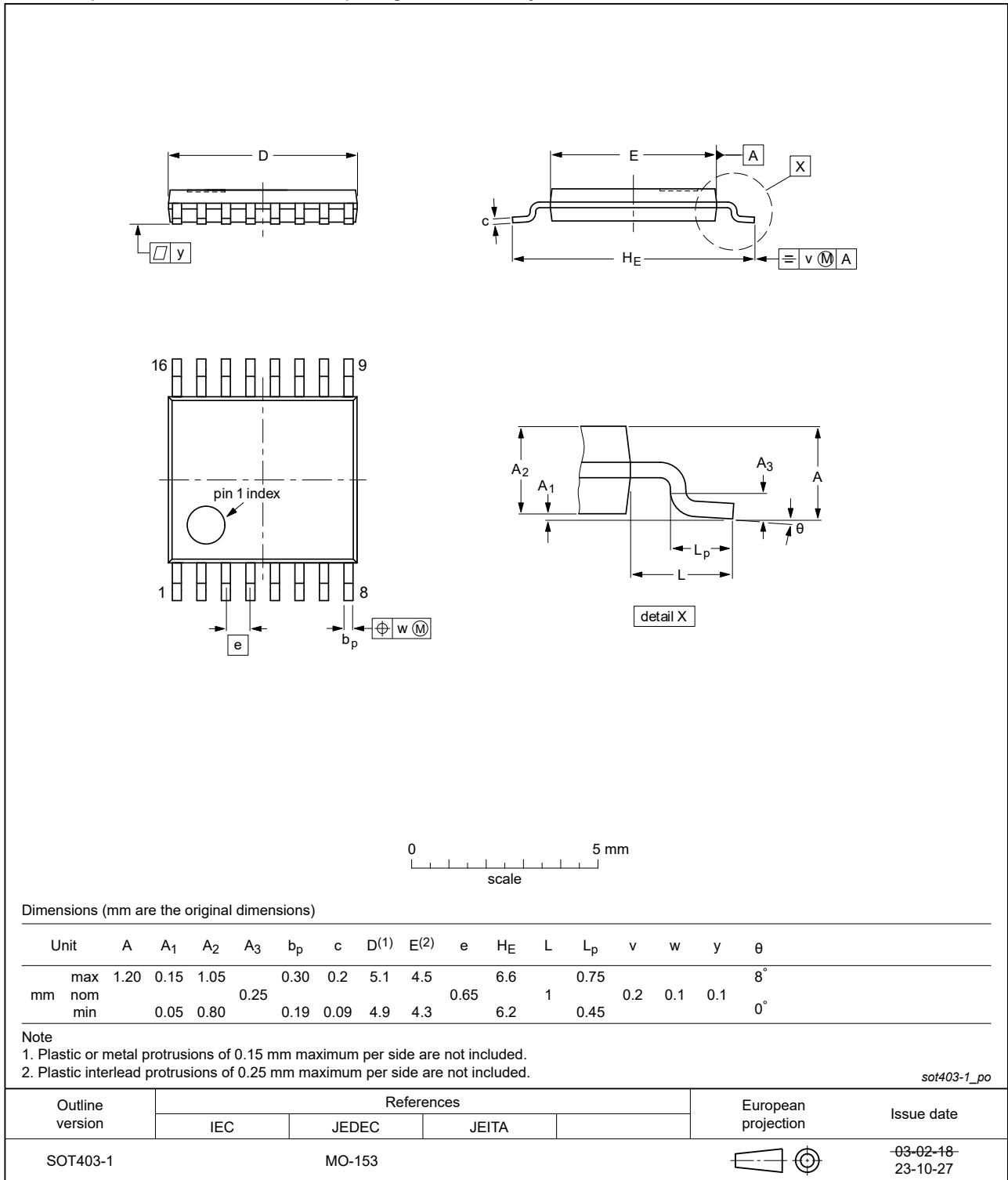


Fig. 22. Package outline SOT403-1 (TSSOP16)

13. Abbreviations

Table 13. Abbreviations

| Acronym | Description |
|---------|---|
| ANSI | American National Standards Institute |
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| ESDA | ElectroStatic Discharge Association |
| HBM | Human Body Model |
| JEDEC | Joint Electron Device Engineering Council |

14. Revision history

Table 14. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------|---|-----------------------|---------------|------------------|
| HEF4053B v.14 | 20240725 | Product data sheet | - | HEF4053B v.13 |
| Modifications: | <ul style="list-style-type: none"> • Section 2: ESD specification updated according to the latest JEDEC standard. • Fig. 21, Fig. 22: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153 | | | |
| HEF4053B v.13 | 20211221 | Product data sheet | - | HEF4053B v.12 |
| Modifications: | <ul style="list-style-type: none"> • The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Section 1 and Section 2 updated. • Table 4: Derating values for P_{tot} total power dissipation updated. • Table 13 updated. | | | |
| HEF4053B v.12 | 20160325 | Product data sheet | - | HEF4053B v.11 |
| Modifications: | <ul style="list-style-type: none"> • Type number HEF4053BP (SOT38-4) removed. | | | |
| HEF4053B v.11 | 20140911 | Product data sheet | - | HEF4053B v.10 |
| Modifications: | <ul style="list-style-type: none"> • Fig. 19: Test circuit modified | | | |
| HEF4053B v.10 | 20111117 | Product data sheet | - | HEF4053B v.9 |
| Modifications: | <ul style="list-style-type: none"> • Legal pages updated. • Changes in Section 1, Section 2, and Section 3. | | | |
| HEF4053B v.9 | 20100325 | Product data sheet | - | HEF4053B v.8 |
| HEF4053B v.8 | 20100224 | Product data sheet | - | HEF4053B v.7 |
| HEF4053B v.7 | 20091127 | Product data sheet | - | HEF4053B v.6 |
| HEF4053B v.6 | 20090924 | Product data sheet | - | HEF4053B v.5 |
| HEF4053B v.5 | 20090825 | Product data sheet | - | HEF4053B v.4 |
| HEF4053B v.4 | 20090713 | Product data sheet | - | HEF4053B_CNV v.3 |
| HEF4053B_CNV v.3 | 19950101 | Product specification | - | HEF4053B_CNV v.2 |
| HEF4053B_CNV v.2 | 19950101 | Product specification | - | - |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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